AMD Ryzen™ 7040 Series

Technology Overview

Mahesh Subramony
AMD Senior Fellow, Client Architecture

David Kramer
AMD Fellow, Client Architecture

Indrani Paul
AMD Senior Fellow, Client Architecture

Hot Chips 2023
AMD Ryzen™ 7040 Series for Mobile - Introduction

"ZEN 4" Core
- High performance and efficient x86 cores
- Up to 13%* higher IPC

RDNA™ 3 Graphics
- Improved perf/W per compute unit

XDNA AI Engine
- First integrated AI engine on an x86 processor, powering AMD Ryzen™ AI

Technology
- Higher transistor density with TSMC N4P
- Accelerators include video, display, audio

Tailored compute for every client use-case

* See Endnotes: RPL-005, RPL-006, PHX-3, PHX-25, PHX-29, GD-220
AMD Ryzen™ 7040 Series for Mobile – The ‘Phoenix’ SoC

128-Bit Flexible Memory Controllers
- DDR5 5600 MT/s
- LPDDR5 7500 MT/s

16-core, 16-thread “Zen 4” CCX
- 16MB L3 Cache
- Complete System Connectivity

RDNA3
- 12 compute units
- 2MB L2 Cache
- Accelerated Multimedia Experience

AMD Radeon™ 700M Graphics

Infinity Fabric™
- X2 X32 DDR5
- X2 X32 LPDDR5
- X2 X32 DDR5
- X32 LPDDR5

- CPU CORE
- CPU CORE
- CPU CORE
- CPU CORE
- CPU CORE
- CPU CORE
- CPU CORE
- CPU CORE

- PCIe 4.0
- USB-C® (w/DP Mode)
- NVMe PCIe 4.0
- Wireless Managability Subsystem
- PCIe 4.0 Discrete GFX

- Microsoft Pluton Processor
- AMD Platform Security Processor

- System Management Unit
- Video Codec VCN 3.1
- Audio ACP 6

- Sensor Fusion Hub

- 4th Gen Display Controller
- 4 Display Support DISPLAYPORT™ 2 HDMI® 2.1
- Integrated Sensor Fusion Hub

* Certain capabilities and features dependent upon OEM enablement
Significant Density Increase – Efficiency Within Budget

4nm “Phoenix” Die

<table>
<thead>
<tr>
<th>Technology</th>
<th>TSMC N4 – 15-layer metal</th>
</tr>
</thead>
<tbody>
<tr>
<td>Transistor count</td>
<td>25.4B</td>
</tr>
<tr>
<td>Die size</td>
<td>178 mm²</td>
</tr>
</tbody>
</table>

In BGA Package

- BGA: 25 x 35 x 1.38mm

Nearly 2x transistors vs. previous “Rembrandt” SoC

15% smaller die
AMD Ryzen™ 7040 Series – Performance At a Glance

- "Zen 4" Cores in mobile form factor
- Improved graphics performance efficiency
- Multicore performance improvements with focus on efficiency
- Integrated Ryzen AI to deliver better audio/video experiences
- ROC Power improvements to improve battery life and active power efficiency

**Performance At a Glance**

- **16%** More single thread performance
- **25%** More multi thread performance
- **22%** More gfx Performance
- **15%** Higher productivity

<table>
<thead>
<tr>
<th>Category</th>
<th>AMD Ryzen™ 7 7840HS</th>
<th>AMD Ryzen™ 7 6800HS</th>
</tr>
</thead>
<tbody>
<tr>
<td>CPU Single Thread</td>
<td></td>
<td></td>
</tr>
<tr>
<td>CPU Multi Thread</td>
<td></td>
<td></td>
</tr>
<tr>
<td>GPU Performance</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Productivity</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

See PHX-18
Core Architecture
"Zen 4" Optimized for APU

- Branch Prediction improvements
- Larger Op-Cache
- Larger Instruction Retire Queue
- Larger Int/FP register file
- Deeper buffers throughout the core
- Power efficient AVX-512 support in the Floating-Point Unit
- Load/Store improvements
- L2 Cache 1M, 8-way
AMD Ryzen™ 7040 Series
More Performance on Windows Notebooks

Application Performance

Up to

- Content Creation: 129%
- Web: 137%
- Productivity: 139%
- Passmark: 189%
- Media encode: 228%

Core i7-1360P with Iris Xe Graphics vs. Ryzen 7 7840U with Radeon™ 780M graphics

See endnotes PHX-26, PHX-27
Graphics Architecture
AMD Radeon™ 700M Series

RDNA™ 3 Graphics Architecture Capabilities

GPU Max Frequency increased to 2.8 GHz
GPU frequencies up to 700MHz higher in Ryzen5

Peak Performance Increased
8.6 TFLOPS (FP16) – 1.8 TFLOPS higher

Massive Bandwidth Increase
Improved DDR5/LPDDR5 support

Incredible Power Efficiency
Via both compute and multimedia accelerators

Radeon™ 700M Block Diagram

Radeon™ 780M
12 Cores, up to 2.8GHz, 4 RB+
On AMD Ryzen™ 7 and 9

Radeon™ 760M
8 Cores, up to 2.6GHz, 2 RB+
On AMD Ryzen™ 5

* See Endnote: GD-151
AMD Ryzen™ 7040 Series
Incredible Gaming Performance

Built-in Radeon™ 780M Performance
1920x1080 Resolution
Low Image Quality Preset, Up to

- DOTA 2: 130%
- Strange Brigade: 137%
- CS:GO: 140%
- Total War: Three Kingdoms: 145%
- Total War: Warhammer 2: 146%
- League of Legends: 162%
- Far Cry 6: 163%
- Shadow of the Tomb Raider: 178%
- World of Tanks Encore: 191%
- Cyberpunk 2077: 239%

Core i7-1360P with Iris Xe Graphics
Ryzen 7 7840U with Radeon™ 780M graphics

See endnote PHX-28
AMD Ryzen™ 7040 Series
Improved Compute, Customized Accelerators

New Zen4 and RDNA3 Architectures
Generational improvements in efficient performance

AI and Domain Specific Accelerators
XDNA, Multimedia accelerators, SOC efficiencies

See endnotes GD-150, GD-151, GD-2207
AMD Ryzen™ 7040 Series
Technology Overview

David Kramer
Client SoC Architecture, AMD
AMD XDNA Architecture
The First Integrated AI Engine on an x86 Processor

XDNA Architecture Capabilities

**Broad AI Model Support**
Transformers, CNNs, others

**Peak Performance**
Up to 10 INT8 TOPs, 20 INT4 TOPs, 5 BF16 TFLOPs

**Real-time Performance**
Up to 4 concurrent spatial streams (DNN DPU);
More responsive AI experiences compared to single stream

**Advanced Features**
50% weight sparsity

**Optimized for Power Efficiency**
Fine-grained clock gating

* See Endnote: PHX-3
AMD Ryzen™ AI Use Cases

Use-Cases
- MS Win Studio AI Effects
  - Video Conferencing Features
  - Automatic framing
  - Eye contact
  - Background effects
- Personal AI assistant
- AI-generated graphics enhancements
- Content creation
- Speech

Benefits of Ryzen AI
- Realtime Performance and Power
- Security
- Cost

WINDOWS STUDIO EFFECTS PACK

EYE CONTACT CORRECTION

STANDARD / PORTRAIT BLUR

AUTO FRAMING
SoC Power Efficiency Enables Rich User Experiences

New Z8 Deep Low Power State
Deeper power state for brief periods of idle or low intensity activity

New AI Inference Engine (XDNA) Power Management
DVFS based on demand, hierarchical clock gating, and power gating

New Memory Controls
DDR PHY DVFS based on data rates

Improved Power Gating and IP Efficiency
USB PHY with enhanced power gating improve and macro circuit reductions

New Platform Optimizations
Software tuning for NVMe power optimization

Modern Standby Improvements
Save-restore acceleration and power optimization using low power PLL circuits

New Smart Scenario Detection Algorithm
Intelligent CPU and fabric frequency management in selective workloads
Infinity Fabric
Power Optimized for Mobile

Better Power Efficiency¹
- 4nm technology
- Optimized fabric performance states
- Added low-power retention state
- Improved dynamic power optimization

Significantly Improved Memory Bandwidth¹
- DDR5-5600 and LPDDR5x-7500

*¹: Vs. Ryzen 6040 series APU
Radeon™ Multimedia Engine 4th GEN

Improved Video Codec Acceleration
- New AV1 encode acceleration
- Up to 200% speedup vs. prior gen
- Improved efficiency for all codecs

<table>
<thead>
<tr>
<th>Supports up to</th>
<th>Decode</th>
<th>Encode</th>
</tr>
</thead>
<tbody>
<tr>
<td>AV1 8b/10b</td>
<td>1080p840 &gt;8k45</td>
<td>1080p720 &gt;8k45</td>
</tr>
<tr>
<td>H.265 HEVC 8b/10b</td>
<td>1080p840 &gt;8k45</td>
<td>1080p600 &gt;8k30</td>
</tr>
<tr>
<td>H.264 MPEG-4 8b</td>
<td>1080p960 4k360</td>
<td>1080p600 4k150</td>
</tr>
<tr>
<td>VP9 8b/10b</td>
<td>1080p840 &gt;8k45</td>
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* Dependent upon OEM enablement

See Endnotes, GD-176.
Enhanced Audio Co-Processor

Expanded DSP Capacity: 2\textsuperscript{nd} DSP, more SRAM, lower-power clocking

Enables additional simultaneous low power audio use-cases
- Low-power playback on speakers and headphones
- Low-power playback on Bluetooth and USB
- Capture audio processing for noise reduction

Wake on audio
- Ultrasound presence detection
- Keyword spotting

Efficient integrated solution

* Dependent upon OEM enablement

* See Endnote: GD-201
Ultrasound Presence Detection

AMD audio hardware and driver stack

- Infrastructure for 3rd parties to run ultrasound based human presence detection (HPD) algorithm in ACP DSP
- Provides power saving benefits over CPU implementation
Platform Optimization
Ryzen 7000 Series Upgraded Platform for Efficient Operation and Best User Experience

High Speed USB-C Connectivity
USB4®

PCI Express®
GEN 4

System Memory
LPDDR5x/DDR5

Display
AMD Freesync™ PSR-SU, DisplayPort 2.0, HDMI2.1

Audio & Teleconference
USB3.2 for camera and secure bio

* See Endnotes: GD-127
Introducing

**AMD Ryzen™ 7040 Series**

Best-in-class Ultrathin Mobile Performance

- Up to 8-Cores 16-Threads “Zen 4” Technology
- Up to 5.1GHz Max Boost
- AMD Radeon™ 700M Graphics RDNA™ 3 Technology
- AMD Ryzen™ AI AMD XDNA™ Architecture*
- 15-30W TDP

* on select models

See endnotes PHX-25, PHX-29, GD-150
Thank You
to the global AMD teams
that made the Ryzen™ 7040 Processor possible
Endnotes

- PHX-3 As of August 2022, select Ryzen™ 7040 processors for mobile with dedicated AI hardware are the only x86 PC processors with dedicated AI hardware.
- PHX-25 Testing as of April 2023 by AMD Performance Labs using Cinebench R23, 3DMark TimeSync, PCMark 10, Passmark 10, Speedometer. Configuration for AMD Ryzen™ 7 7840U: AMD Mayan reference board, 16GB RAM, Samsung SSD 980 PRO 1TB, BIOS RMH0081tA, integrated Radeon™ 700M graphics, Windows 11 Pro. Configuration for AMD Ryzen™ 7 7800U: Lenovo Thinkpad T14s Gen 3, 32GB RAM, 2TB SSD, BIOS R22ET22WT12 (0.22), integrated Radeon™ 600M graphics, Windows 11 Pro. 3DMark is a registered trademark of Futuremark Corporation. PC manufacturers may vary configurations yielding different results. Results may vary.
- PHX-26 Testing as of April 2023 by AMD Performance Labs using PCMark 10, Passmark, Kraken, and Procyon Microsoft productivity benchmarks. The relevant class is defined as ultrathin processors with 28W TDP currently available in market as of April 2023. Configuration for AMD Ryzen™ 7 7840U: AMD Mayan reference board, 16GB RAM, SSD 1TB, BIOS RMH0081tA, integrated Radeon 700M graphics, Windows 11 Pro. Configuration for Intel Core i7-1360P: MSI Summit Flip 14, 32GB RAM, 1TB SSD, integrated Intel Iris xe graphics, Windows 11 Pro. PassMark is a registered trademark of PassMark Software Pty Ltd. PCMARK is a registered trademark of UL Solutions. PC manufacturers may vary configurations yielding different results. Results may vary.
- PHX-27 Testing as of April 2023 by AMD Performance Labs using PCMark 10 Digital Content Creation (DCC), HandBrake, Blender, and LAME MP3 benchmarks. The relevant class is defined as ultrathin x86 processors with 28W TDP currently available in market as of April 2023. Configuration for AMD Ryzen™ 7 7840U: AMD Mayan reference board, 16GB RAM, SSD 1TB, BIOS RMH0081tA, integrated Radeon 700M graphics, Windows 11 Pro. Configuration for Intel Core i7-1360P: MSI Summit Flip 14, 32GB RAM, 1TB SSD, integrated Intel Iris xe graphics, Windows 11 Pro. PCMARK is a registered trademark of UL Solutions. PC manufacturers may vary configurations yielding different results. Results may vary.
- PHX-28 Testing as of April 2023 by AMD Performance Labs using 3DMark TimeSync and the following game titles tested at 1080P, low settings: Far Cry 6, CS:GO, Grand Theft Auto V, Assassin’s Creed Valhalla, Borderlands 3, DOTA 2. The relevant class is defined as ultrathin x86 processors with integrated graphics and 28W TDP currently available in market as of April 2023. Configuration for AMD Ryzen™ 7 7840U: AMD Mayan reference board, 16GB RAM, SSD 1TB, BIOS RMH0081tA, integrated Radeon 700M graphics, Windows 11 Pro. Configuration for Intel Core i7-1360P: MSI Summit Flip 14, 32GB RAM, 1TB SSD, integrated Intel Iris xe graphics, Windows 11 Pro. Configuration for Intel Core i9-13950HX: MSI GF65 Thin 11UE, 16GB RAM, 1TB SSD, BIOS R23, 3DMark is a registered trademark of UL Solutions. PC manufacturers may vary configurations yielding different results. Results may vary.
- PHX-29 Testing as of April 2023 by AMD Performance Labs using 3DMark TimeSync and the following game titles tested at 1080P, low settings: F1 2021, Far Cry 6, CS:GO, Grand Theft Auto V, World of Tanks Encore, Assassin’s Creed Valhalla, Borderlands 3, DOTA 2. The relevant class is defined as ultrathin x86 processors with integrated graphics and 28W TDP currently available in market as of April 2023. Configuration for AMD Ryzen™ 7 7840U: AMD Mayan reference board, 16GB RAM, SSD 1TB, BIOS RMH0081tA, integrated Radeon 700M graphics, Windows 11 Pro. Configuration for AMD Ryzen 7 6800U: Lenovo Thinkpad T14s Gen 3, 32GB RAM, 2TB SSD, BIOS R22ET22WT12 (0.22), integrated Radeon™ 600M graphics, Windows 11 Pro. 3DMark is a registered trademark of UL Solutions. PC manufacturers may vary configurations yielding different results. Results may vary.
- RPL-4 Based on a smaller node size (5nm) of AMD x86 desktop processors, August 2022
- GD-150 Boost Clock Frequency is the maximum frequency achievable on the CPU running a bursty workload. Boost clock achievability, frequency, and sustainability will vary based on several factors, including but not limited to: thermal conditions and variation in applications and workloads.
- GD-151 Boost Clock Frequency is the maximum frequency achievable on the GPU running a bursty workload. Boost clock achievability, frequency, and sustainability will vary based on several factors, including but not limited to: thermal conditions and variation in applications and workloads.
- GD-176 Video codec acceleration (including at least the HEVC (H.265), H.264, VP9, and AV1 codecs) is subject to and not operable without inclusion/installation of compatible media players.
Endnotes

RMB-7: Based on testing by AMD as of 12/14/2021. The integrated graphics performance of Ryzen™ 6000 Series processors can get up to 45 FPS average in the majority of 11 tested PC game titles at 1080p resolution with low settings, a threshold no other integrated graphics processor has reached before, including Intel Iris Xe graphics, and Ryzen™ 5000 Series graphics.

RMB-22: Based on testing by AMD as of 12/14/2021. CPU performance evaluated with a geomean of 9 multi-threaded content creation and CPU tests. GPU performance evaluated with 3DMark® Time Spy. Battery life evaluated with hours of continuous local 1080p video playback using the h.264 video codec. System configuration for Ryzen™ 7 5800U CPU/GPU performance: HP ProBook 635 Aero G8 configured with 2x8GB DDR4-3200 (22-22-22), Windows® 11 22000.282, Samsung 980 Pro 1TB SSD, 15W nominal processor TDP, GPU driver 27.20.21026, BIOS T83. System configuration for Ryzen™ 7 5800U CPU/GPU performance: AMD reference motherboard configured with 4x4GB LPDDR5-6400 (40-39-45-90). Windows® 11 22000.282, Samsung 980 Pro 1TB SSD, 15W nominal processor TDP, GPU driver 30.0, BIOS TRM0081D. System configuration for battery life duration: AMD reference motherboard(s), Ryzen™ 7 5800U @ 15W and 2x8GB LPDDR4, Ryzen™ 7 6800U @ 15W and 2x8GB LPDDR5, 1080p eDP PSR display with Varibright at 150 nits. Samsung 980 Pro 1TB SSD, WLAN enabled and disconnected. Windows 11 22000.282, BIOS 103BRC1 (6800U) and 090RC6NT (6800U). Video file: 1920x1080, 23.976 FPS, h.264.

RMB-23: Based on testing by AMD as of 12/14/2021. CPU performance evaluated with a geomean of 9 multi-threaded content creation and CPU tests. GPU performance evaluated with 3DMark® Time Spy. Battery life evaluated with hours of continuous 1080p local video playback using the h.264 video codec. System configuration for Ryzen™ 7 5800U CPU/GPU performance: HP ProBook 635 Aero G8 configured with 2x8GB DDR4-3200 (22-22-22), Windows® 11 22000.282, Samsung 980 Pro 1TB SSD, 15W nominal processor TDP, GPU driver 27.20.21026, BIOS T83. System configuration for Ryzen™ 7 6800U CPU/GPU performance: AMD reference motherboard configured with 4x4GB LPDDR5-6400 (40-39-45-90). Windows® 11 22000.282, Samsung 980 Pro 1TB SSD, 28W nominal processor TDP, GPU driver 30.0, BIOS TRM0081D. System configuration for battery life duration: AMD reference motherboard(s), Ryzen™ 7 5800U @ 15W and 2x8GB LPDDR4, Ryzen™ 7 6800U @ 28W and 2x8GB LPDDR5, 1080p eDP PSR display with Varibright at 150 nits. Samsung 980 Pro 1TB SSD, WLAN enabled and disconnected. Windows 11 22000.282, BIOS 103BRC1 (5800U) and 090RC6NT (6800U). Video file: 1920x1080, 23.976 FPS, h.264.

RMB-45: Based on testing by AMD and notebookcheck.com as of 02/07/2022 using the Cinebench nT benchmark / Sustained power limit for each system. Configuration for Ryzen™ 9 5900HS system: ASUS G14 configured with 2x8GB DDR5-4800, Windows 11 22000.282, 1TB SSD, Radeon 6800S graphics, sustained processor power limit of 35W. Data for Core i9-12900HK provided by notebookcheck.com: https://www.notebookcheck.net/Intel-Core-i9-12900HK-Processor-Benchmarks-and-Specs.589165.0.html. Configuration for Core i9-12900HK: MSI GE76 Raider configured with 2x16GB DDR5-4800, Windows 11, 2x1GB SSD, GeForce GTX 3080 Ti, sustained processor power limit of 110W. Results may vary.

RPL-005: Testing as of 15 August, 2022, by AMD Performance Labs using the following hardware: AMD AM5 Reference Motherboard with AMD Ryzen™ 7 7700X with G.Skill DDR5-6000C30 (F5-6000J3038F16GXX2-T25N) with AMD EXPO™ loaded, AMD AM4 Reference Motherboard with AMD Ryzen™ 7 5800X and DDR4-3600C16. Processors fixed to 4GHz frequency with 8C16 enabled and evaluated with 22 different workloads. ALL SYSTEMS configured with NZXT Kraken X63, open air test bench. Radeon™ RX 6950XT (driver 22.7.1 Optional), Windows® 11 22000.856, AMD Smart Access Memory/PCIe® Resizable Base Address Register ("ReBAR") ON, Virtualization-Based Security (VBS) OFF. Results may vary.


RPL-006: Testing with Geekbench 5.4.x as of 15 August, 2022, by AMD Performance Labs using the following hardware: AMD AM5 Reference Motherboard with AMD Ryzen™ 9 7950X with G.Skill DDR5-6000C30 (F5-6000J3038F16GXX2-T25N) with AMD EXPO™, versus AMD AM4 Reference Motherboard with Ryzen™ 9 5950X and DDR4-3600C16, ALL SYSTEMS configured with NZXT Kraken X63, open air test bench. Radeon™ RX 6950XT (driver 22.7.1 Optional), Windows® 11 22000.856, AMD Smart Access Memory/PCIe® Resizable Base Address Register ("ReBAR") ON, Virtualization-Based Security (VBS) OFF. Results may vary.

RPL-007: Testing as of 15 August, 2022, by AMD Performance Labs using the following hardware: AMD Socket AM5 Reference Motherboard with AMD Ryzen™ 9 7950X, Ryzen™ 5 7600X and G.Skill DDR5-6000C30 (F5-6000J3038F16GXX2-T25N) with AMD EXPO™; versus AMD Socket AM4 Reference Motherboard with Ryzen™ 9 5950X, Ryzen™ 9 5900X, Ryzen™ 5 5600X; versus ROG Maximus Z690 Hero with Core i9-12900K and G.Skill DDR5-6000C30 (F5-6000J3038F16GXX2-T25N) with AMD EXPO™ loaded, ALL SYSTEMS configured with NZXT Kraken X63, open air test bench, Radeon™ RX 6950XT (driver 22.7.1 Optional). Windows® 11 22000.856, AMD Smart Access Memory/PCIe® Resizable Base Address Register (‘ReBAR’) ON, Virtualization-Based Security (VBS) OFF. All games tested at 1920x1080 with HIGH in-game preset and the chronologically newest graphics industry API available within the game’s rendering engine (e.g. Vulkan® over OpenGL™, DirectX® 12 over DirectX® 11). Results may vary.
Endnotes

RMP-39: Based on testing by AMD Labs as of 4/11/22. Battery life evaluated in hours of continuous 1080p local video playback with a HP Elitebook 865 G9 configured with an AMD Ryzen 7 PRO 6850U processor with Radeon 680M graphics, 76 WHr battery, 150 nit screen brightness, 256GB HDD, 8GB memory, Win 10 Pro, video resolution of 1920 x 1200 x 60 Hz and the power slider set to “better battery.” Actual battery life will vary based on several factors, including, but not limited to: product configuration and usage, software, operating conditions, wireless functionality, power management settings, screen brightness and other factors. The maximum capacity of the battery will naturally decrease with time and use.

GD-127: AMD FreeSync™ technology requires AMD Radeon™ graphics and a display that supports FreeSync technology as certified by AMD. AMD FreeSync™ Premium technology adds requirements of mandatory low framerate compensation and at least 120 Hz refresh rate at minimum FHD. AMD FreeSync™ Premium Pro technology adds requirements for the display to meet AMD FreeSync Premium Pro compliance tests. See www.amd.com/freesync for complete details. Confirm capability with your system manufacturer before purchase.

GD-149: Wi-Fi™ 6 and Bluetooth® 5.0 availability varies by laptop manufacturer and are system configuration dependent. Check with your laptop manufacturer for compatibility information.

GD-151: Boost Clock Frequency is the maximum frequency achievable on the GPU running a bursty workload. Boost clock achievability, frequency, and sustainability will vary based on several factors, including but not limited to: thermal conditions and variation in applications and workloads.

GD-201: AI-powered noise cancellation and USB4® require OEM enablement. Please check with your PC manufacturer prior to purchase.

GD-220: Ryzen™ AI technology is compatible with all AMD Ryzen 7040 series processors except the Ryzen 5 7540U and Ryzen 3 7440U, OEM enablement is required. Please check with your system manufacturer for feature availability prior to purchase.

RMB-83: Based on testing by AMD as of 4/22/2022 using the following benchmarks: 3DMark Time Spy and 3DMark Fire Strike. Configuration for Ryzen 7 5800U/5900HX processor-based systems: AMD reference motherboard configured with Samsung SSD 970 PRO 512GB, PCIe (NVMe), 2x8GB, 16 GB RAM, SR, DDR4-3200, Windows 10 Professional 19042, AMD Radeon graphics, GPU driver 27.20.14048.3, and BIOS TCD1003B_193. Configuration for Ryzen 7 6800/6900HX processor-based systems: AMD reference motherboard configured with Samsung SSD 970 PRO 512GB, PCIe (NVMe), 2x16GB, 32GB RAM, SRx8, DDR5-4800, Windows 11 Professional 22000.652, AMD Radeon 680M graphics, GPU driver 30.0.14056.7, BIOS RRM1004aA. PC manufacturers may vary configurations yielding different results. Results may vary.
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